TEMD6200FX01

Vishay Semiconductors



Ambient Light Sensor



DESCRIPTION

TEMD6200FX01 is a high speed and high sensitive PIN photodiode in a miniature flat plastic package. It is spectral sensitivity is closely matched to the human eye.

FEATURES

- Package type: Surface mount
- Package form: 0805
- Dimensions (L x W x H in mm): 2 x 1.25 x 0.85
- Radiant sensitive area (in mm²): 0.27
- AEC-Q101 qualified
- High photo sensitivity
- · Adapted to human eye responsivity
- Angle of half sensitivity: $\varphi = \pm 60^{\circ}$
- Floor life: 168 h, MSL 3, acc. J-STD-020
- (5-2008) · Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Automotive sensors
- Ambient light sensors
- Backlight dimming
- Mobil phones
- Notebooks
- Computers

PRODUCT SUMMARY				
COMPONENT	I _{ra} (μΑ)	φ (deg)	λ _{0.5} (nm)	
TEMD6200FX01	0.04	± 60	430 to 610	

Note

Test condition see table "Basic Characteristics"

ORDERING INFORMATION				
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM	
TEMD6200FX01	Tape and reel	MOQ: 3000 pcs, 3000 pcs/reel	0805	

Note

MOQ: Minimum order quantity

ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Reverse voltage		V _R	16	V
Power dissipation	T _{amb} ≤ 55 °C	Pv	100	mW
Junction temperature		Tj	100	°C
Operating temperature range		T _{amb}	-40 to +100	°C
Storage temperature range		T _{stg}	-40 to +100	°C
Soldering temperature	In accordance with fig. 6	T _{sd}	260	°C
Thermal resistance junction/ambient		R _{thJA}	270	K/W



e

RoHS

COMPLIANT HALOGEN

FREE

GREEN



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BASIC CHARACTERISTICS ($T_{amb} = 25 \text{ °C}$, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Breakdown voltage	I _R = 100 μA, E = 0 lx	V _(BR)	16			V
Reverse dark current	V _R = 10 V, E = 0 lx	I _{ro}		0.1	5	nA
Diode capacitance	$V_{R} = 0 V, f = 1 MHz, E = 0 lx$	CD		60		pF
	$V_{R} = 5 V, f = 1 MHz, E = 0 lx$	CD		24		pF
Reverse light current	$E_e = 1 \text{ mW/cm}^2, \lambda = 550 \text{ nm}, \\ V_R = 5 \text{ V}$	I _{ra}		1		μA
	E _V = 100 lx, CIE illuminant A	I _{ra}	0.03	0.04	0.09	μA
Angle of half sensitivity		φ		± 60		deg
Wavelength of peak sensitivity		λρ		540		nm
Range of spectral bandwidth		λ _{0.5}		430 to 610		nm
Rise time	$U_{R} = 5 \text{ V}, \text{ R}_{L} = 50 \Omega, \text{ TLMW3300}$	t _r		150		ns
Fall time	$U_R = 5 \text{ V}, \text{ R}_L = 50 \Omega, \text{ TLMW3300}$	t _f		150		ns

BASIC CHARACTERISTICS (Tamb = 25 °C, unless otherwise specified)

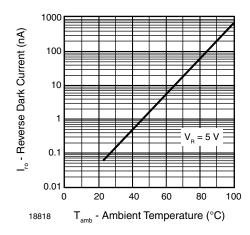


Fig. 1 - Reverse Dark Current vs. Ambient Temperature

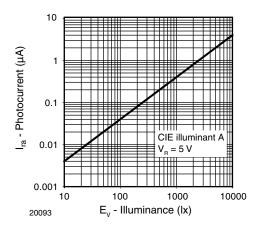


Fig. 2 - Reverse Light Current vs. Illuminance

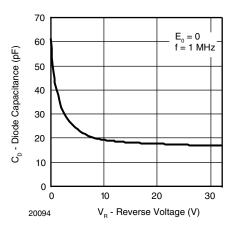


Fig. 3 - Diode Capacitance vs. Reverse Voltage

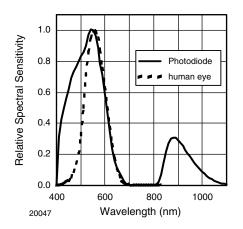


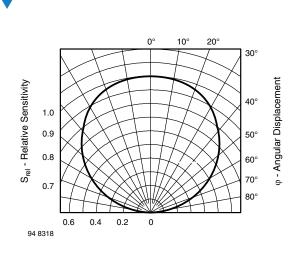
Fig. 4 - Relative Spectral Sensitivity vs. Wavelength

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Fig. 5 - Relative Radiant Sensitivity vs. Angular Displacement

SOLDER PROFILE

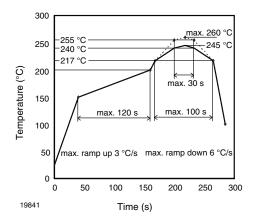


Fig. 6 - Lead (Pb)-free Reflow Solder Profile acc. J-STD-020

DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

Time between soldering and removing from MBB must not exceed the time indicated in J-STD-020: Moisture sensitivity: Level 3 Floor life: 168 h Conditions: $T_{amb} < 30$ °C, RH < 60 %

DRYING

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label. Devices taped on reel dry using recommended conditions:

192 h at 40 °C (+ 5 °C), RH < 5 % or 96 h at 60 °C (+ 5 °C), RH < 5 %.

3

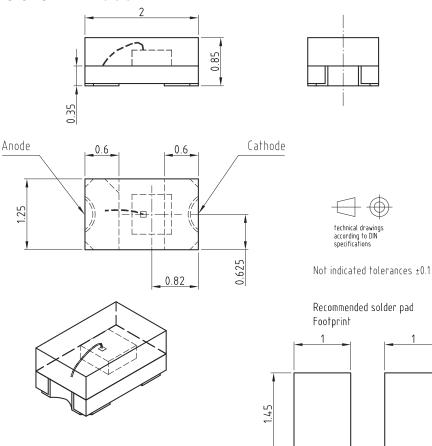


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PACKAGE DIMENSIONS in millimeters

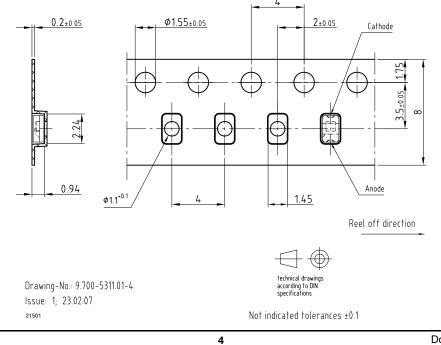
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Drawing-No.: 6.541-5064.01-4 Issue: 2; 23.02.07 20018

BLISTER TAPE DIMENSIONS in millimeters



0.6

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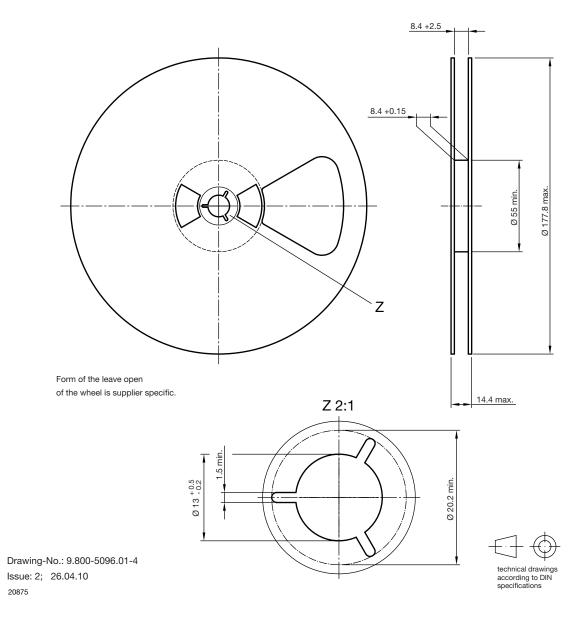
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REEL DIMENSIONS in millimeters



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